



INTERQUIP ELECTRONICS (SHENZHEN) CO LTD.

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Part/Process change notification

PCN issue date: Aug 12th, 2016 (ref# PCN160812)

Product identification	SMCE-2016
产品描述	SMCE-2016
Type of change	Product thickness
改动范围	产品厚度
Reason for change	Improve ceramic package supply flexibility and availability
改动原因	提高陶瓷基座物料的供应灵活性
Description of change	Increase product thickness from 0.5mm max to 0.55mm max
改动描述	产品厚度由 0.5mm max 增加至 0.55mm max
Implementation date of change	Immediate effect
更改日期	即时生效

We hope the above changes will have minimal impact to our customers. Should there are any questions, please contact the associated sales personnel or email us at iql@interquip.com / iqlsz@interquip-china.com

我们希望上述改动仅对客户构成轻微影响, 如对以上改动有任何问题, 欢迎与我们的销售人员联络或电邮至 iql@interquip.com / iqlsz@interquip-china.com